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**Serial Number:** 10/698,503

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## Inventor Information for 10/698503

<b>Inventor Name</b>	<b>City</b>	<b>State/Country</b>
GIESKES, KOENRAAD	DEPOSIT	NEW YORK

Appln Info	Contents	Petition Info	Atty/Agent Info	Continuity Data	Foreign Data	<b>Inventors</b>
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US 20040060170 A1	20040401	Redundant system for assembly of electronic components to substrates	29/740	198/345.3; 29/760; 29/832	Gieskes, Koenraad A.
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US 20020079751 A1	20020627	Variable reluctance motor with reduced	310/51	310/68R	Janisiewicz, Stanislaw Wladyslaw et al.

		noise and vibration			
US 20020079192 A1	20020627	Dual lane conveying apparatus	198/445		Dionne, Peter J. et al.
US 20020047437 A1	20020425	Variable reluctance motor with reduced noise and vibration	310/168	310/12; 310/216	Janisiewicz, Stanislaw Wladyslaw et al.
US 20010045788 A1	20011129	Variable reluctance motor with improved tooth geometry	310/216	310/12; 310/254	Janisiewicz, Stanislaw Wladyslaw et al.
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US 5699934 A	19971223	Dispenser and method for dispensing viscous fluids	222/1	222/386.5; 222/61	Kolcun; Joseph F. et al.

US 5649356 A	19970722	Method and apparatus for supplying and placing components	29/833	29/710; 29/740; 29/743; 29/834; 294/64.1	Gieskes; Koen A.
US 5031818 A	19910716	Soldering machine operating with a protective gas and provided with automatically operating lock doors	228/42	228/221; 228/43	Gieskes; Koen A.
US 4848640 A	19890718	Apparatus for the application of a conductive adhesive medium to a printed circuit board	228/37	228/180.1	Gieskes; Koenraad A.

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